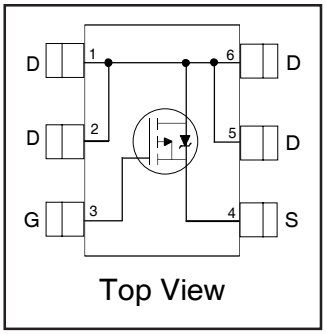
International
IOR Rectifier

IRLTS2242PbF

HEXFET® Power MOSFET

V_{DS}	-20	V
$V_{GS\ max}$	±12	V
$R_{DS(on)\ max}$ (@V_{GS} = -4.5V)	32	mΩ
$R_{DS(on)\ max}$ (@V_{GS} = -2.5V)	55	mΩ
$Q_{g\ typ}$	12	nC
I_D (@T_A= 25°C)	-6.9	A



Top View


TSOP-6

Applications

- Battery operated DC motor inverter MOSFET
- System/Load Switch

Features and Benefits

Features		Benefits
Industry-Standard TSOP-6 Package	results in ⇒	Multi-Vendor Compatibility
RoHS Compliant Containing no Lead, no Bromide and no Halogen		Environmentally Friendlier
MSL1, Consumer Qualification		Increased Reliability

Orderable part number	Package Type	Standard Pack		Note
		Form	Quantity	
IRLTS2242TRPbF	TSOP-6	Tape and Reel	3000	

Absolute Maximum Ratings

	Parameter	Max.	Units
V_{DS}	Drain-to-Source Voltage	-20	V
V_{GS}	Gate-to-Source Voltage	±12	
I_D @ T_A = 25°C	Continuous Drain Current, V_{GS} @ 4.5V	-6.9	A
I_D @ T_A = 70°C	Continuous Drain Current, V_{GS} @ 4.5V	-5.5	
I_{DM}	Pulsed Drain Current ①	-55	
P_D @T_A = 25°C	Power Dissipation	2.0	W
P_D @T_A = 70°C	Power Dissipation	1.3	
	Linear Derating Factor	0.02	W/°C
T_J T_{STG}	Operating Junction and Storage Temperature Range	-55 to + 150	°C

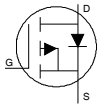
Notes ① through ④ are on page 2

Static @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	-20	—	—	V	V_{GS} = 0V, I_D = -250µA
$\Delta BV_{DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	—	9.4	—	mV/°C	Reference to 25°C, I_D = -1mA
$R_{DS(on)}$	Static Drain-to-Source On-Resistance	—	26	32	mΩ	V_{GS} = -4.5V, I_D = -6.9A ②
		—	45	55		V_{GS} = -2.5V, I_D = -5.5A ②
$V_{GS(th)}$	Gate Threshold Voltage	-0.4	—	-1.1	V	V_{DS} = V_{GS}, I_D = -10µA
$\Delta V_{GS(th)}$	Gate Threshold Voltage Coefficient	—	-3.8	—	mV/°C	
I_{DSS}	Drain-to-Source Leakage Current	—	—	-1.0	µA	V_{DS} = -16V, V_{GS} = 0V
		—	—	-150		V_{DS} = -16V, V_{GS} = 0V, T_J = 125°C
I_{GSS}	Gate-to-Source Forward Leakage	—	—	-100	nA	V_{GS} = -12V
	Gate-to-Source Reverse Leakage	—	—	100		V_{GS} = 12V
gfs	Forward Transconductance	8.5	—	—	S	V_{DS} = -10V, I_D = -5.5A
Q_g	Total Gate Charge	—	12	—	nC	V_{DS} = -10V
Q_{gs}	Gate-to-Source Charge	—	1.5	—		V_{GS} = -4.5V
Q_{gd}	Gate-to-Drain Charge	—	4.3	—		I_D = -5.5A
R_G	Gate Resistance	—	17	—	Ω	
$t_{d(on)}$	Turn-On Delay Time	—	5.8	—	ns	V_{DD} = -10V, V_{GS} = -4.5V
t_r	Rise Time	—	18	—		I_D = -5.5A
$t_{d(off)}$	Turn-Off Delay Time	—	81	—		R_G = 6.8Ω
t_f	Fall Time	—	68	—		
C_{iss}	Input Capacitance	—	905	—	pF	V_{GS} = 0V
C_{oss}	Output Capacitance	—	280	—		V_{DS} = -10V
C_{rss}	Reverse Transfer Capacitance	—	200	—		ƒ = 1.0KHz

Diode Characteristics

	Parameter	Min.	Typ.	Max.	Units	Conditions
I_S	Continuous Source Current (Body Diode)	—	—	-2.0	A	MOSFET symbol showing the integral reverse p-n junction diode.
I_{SM}	Pulsed Source Current (Body Diode) ①	—	—	-55		
V_{SD}	Diode Forward Voltage	—	—	-1.2	V	T_J = 25°C, I_S = -5.5A, V_{GS} = 0V ②
t_{rr}	Reverse Recovery Time	—	41	62	ns	T_J = 25°C, I_F = -5.5A, V_{DD} = -16V
Q_{rr}	Reverse Recovery Charge	—	16	24	nC	di/dt = 100A/µs ②
t_{on}	Forward Turn-On Time	Time is dominated by parasitic Inductance				



Thermal Resistance

	Parameter	Typ.	Max.	Units
$R_{\theta JA}$	Junction-to-Ambient ③	—	62.5	°C/W

Notes:

① Repetitive rating; pulse width limited by max. junction temperature.

② Pulse width ≤ 400µs; duty cycle ≤ 2%.

③ When mounted on 1 inch square copper board.

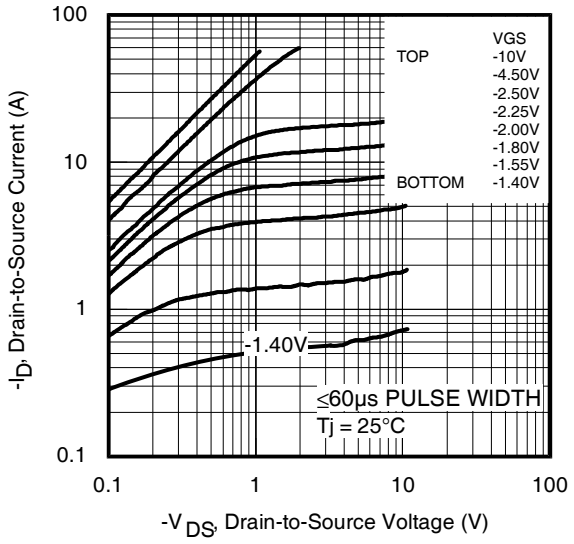


Fig 1. Typical Output Characteristics

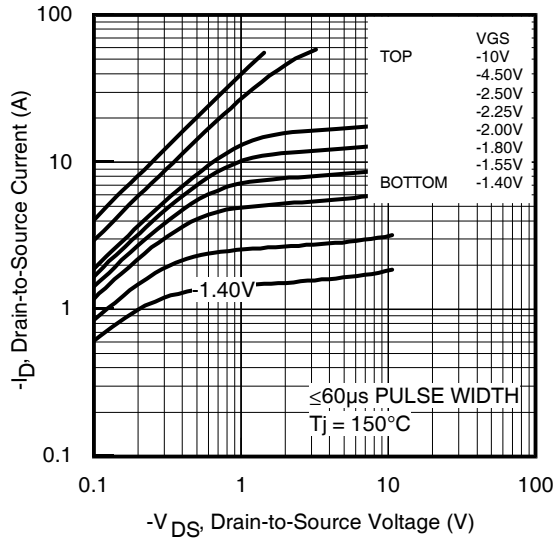


Fig 2. Typical Output Characteristics

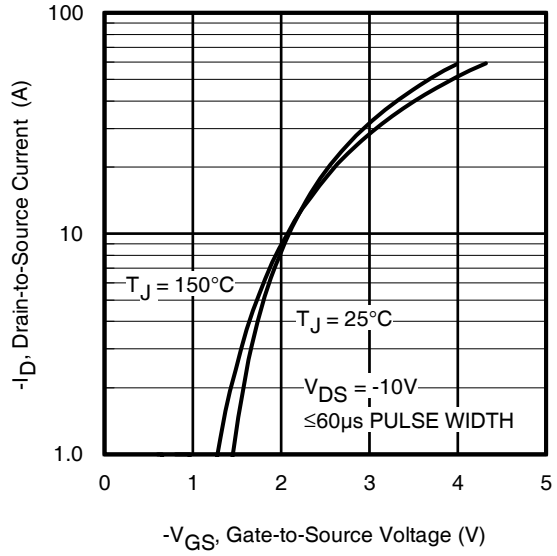


Fig 3. Typical Transfer Characteristics

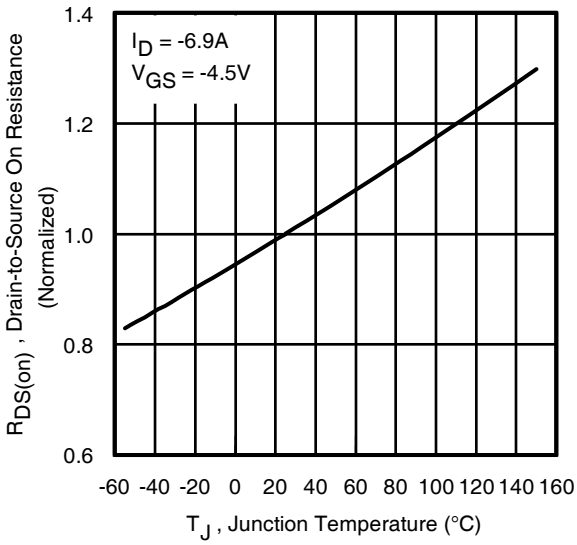


Fig 4. Normalized On-Resistance vs. Temperature

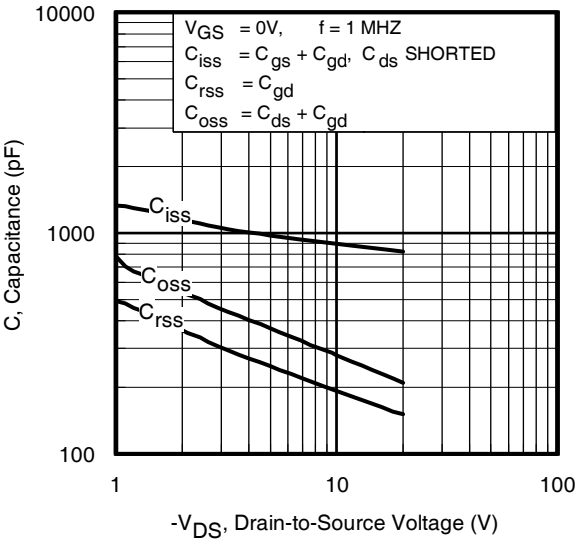


Fig 5. Typical Capacitance vs.Drain-to-Source Voltage

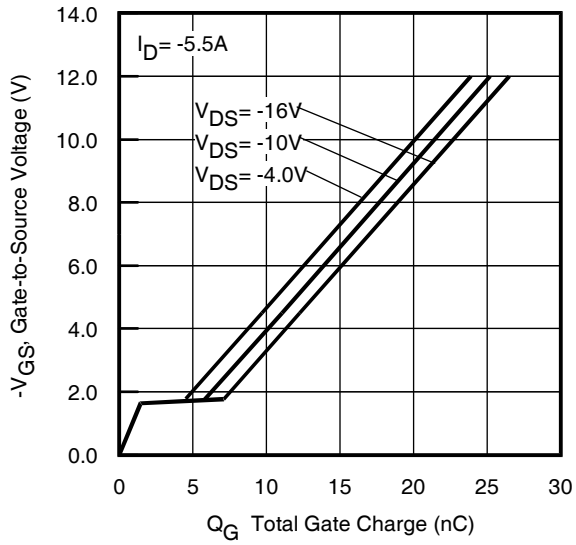


Fig 6. Typical Gate Charge vs.Gate-to-Source Voltage

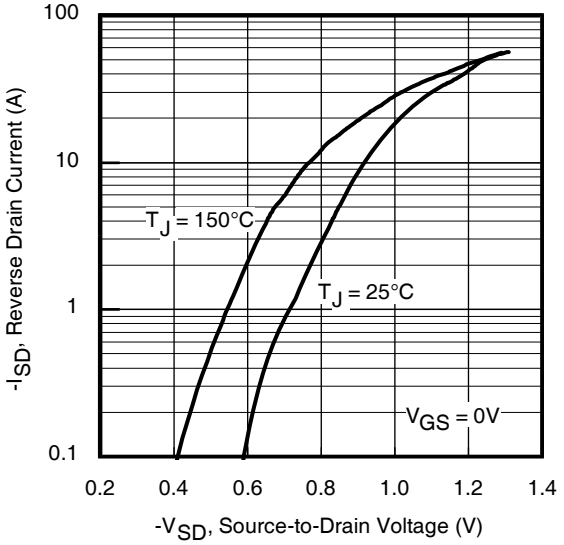


Fig 7. Typical Source-Drain Diode Forward Voltage

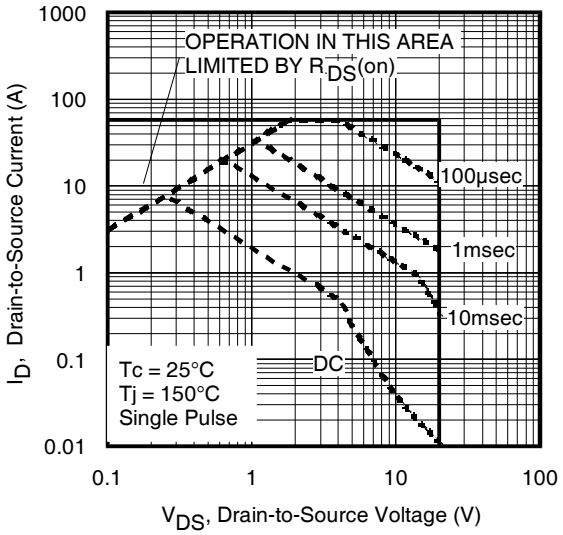


Fig 8. Maximum Safe Operating Area

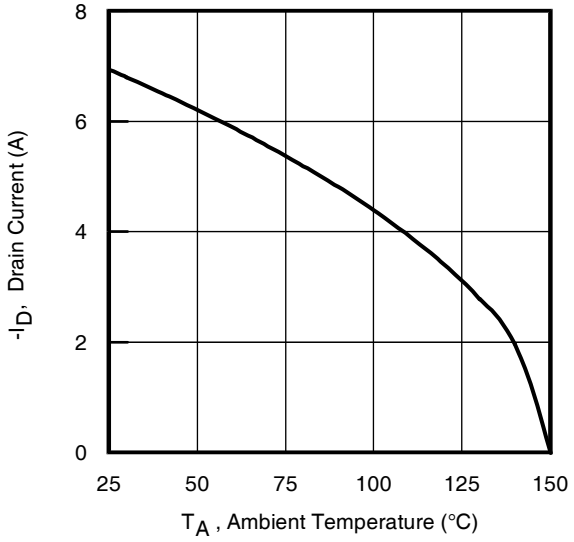


Fig 9. Maximum Drain Current vs. Case Temperature

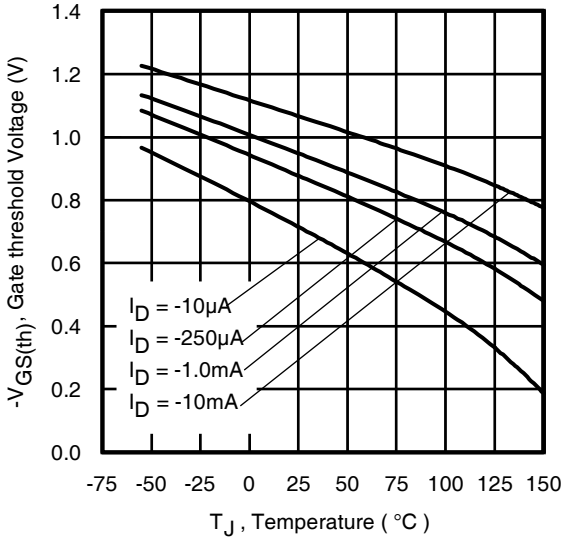


Fig 10. Threshold Voltage vs. Temperature

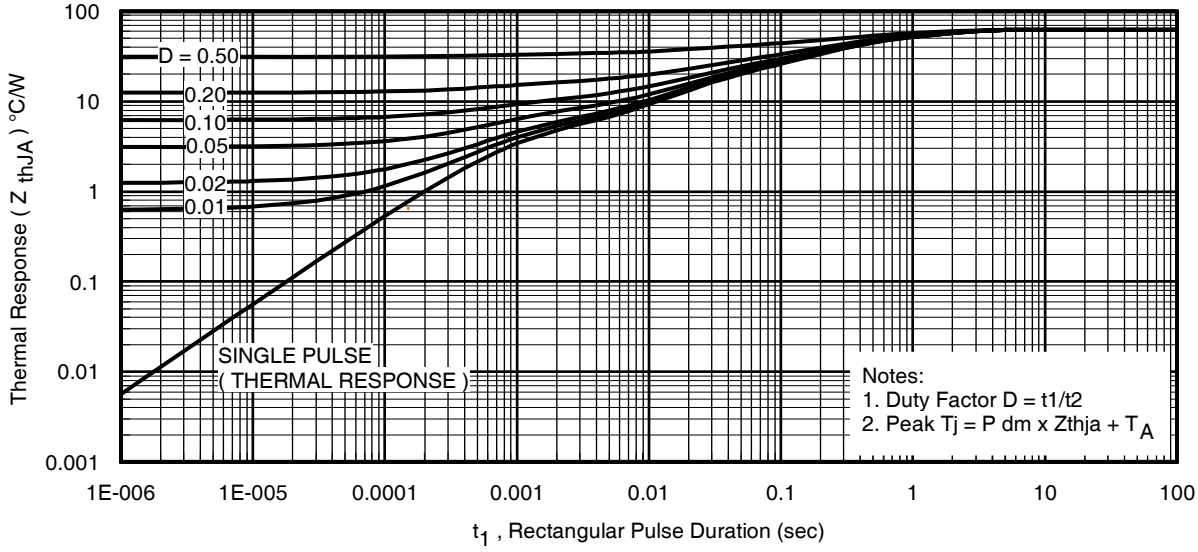


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

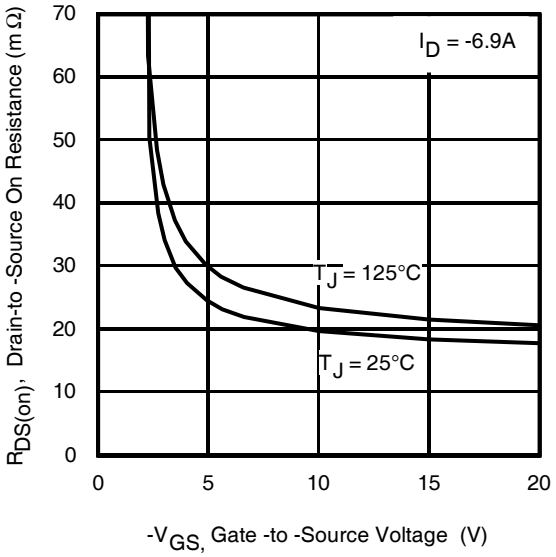


Fig 12. On-Resistance vs. Gate Voltage

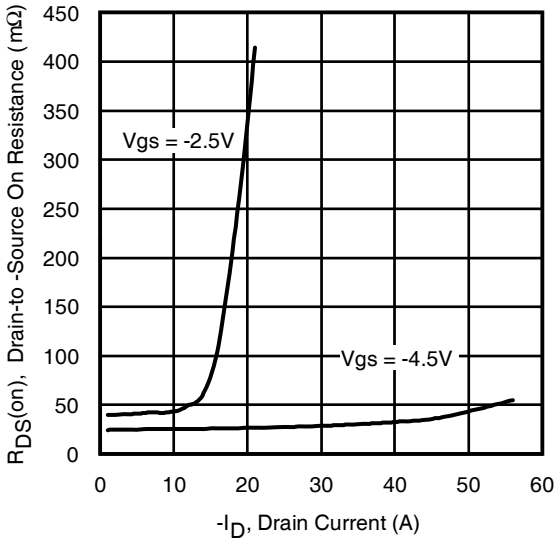


Fig 13. Typical On-Resistance vs. Drain Current

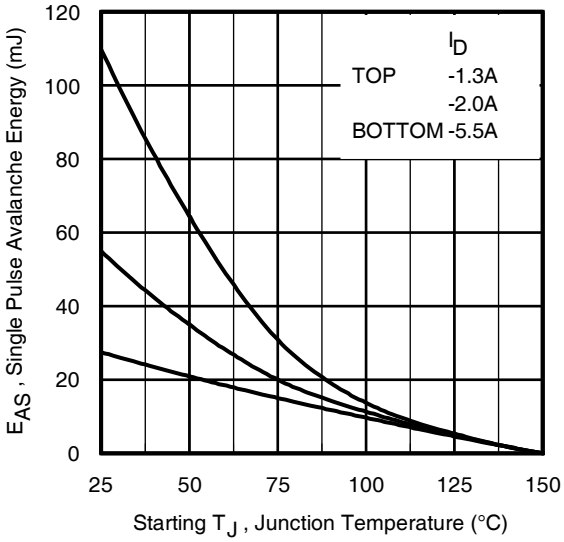


Fig 14. Maximum Avalanche Energy vs. Drain Current

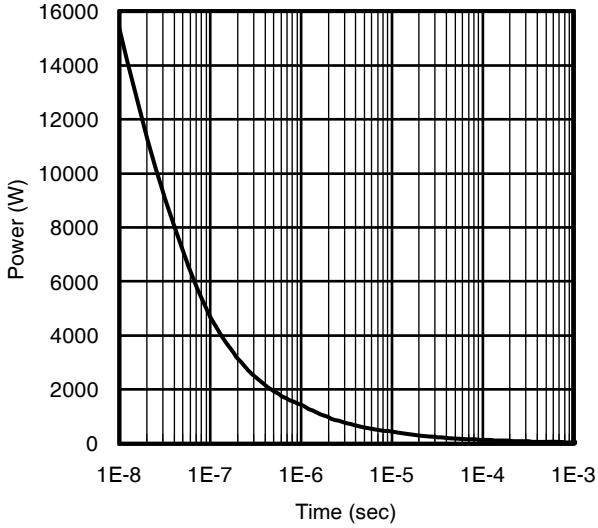
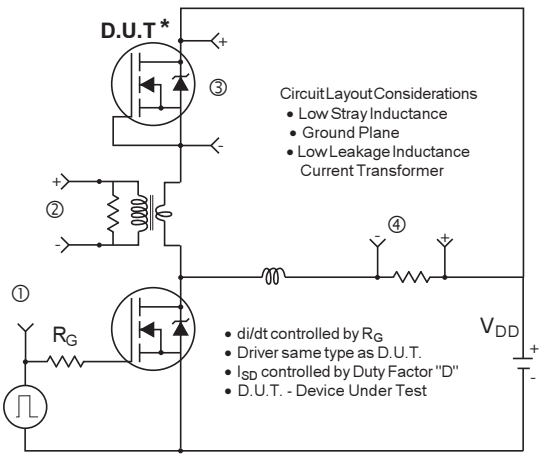
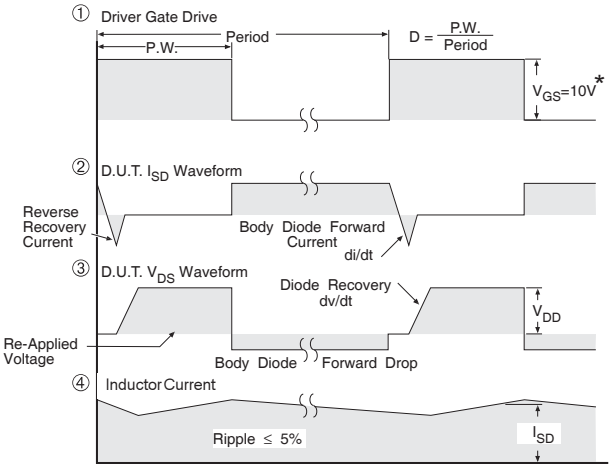


Fig 15. Typical Power vs. Time



* Reverse Polarity of D.U.T for P-Channel



* V_{GS} = 5V for Logic Level Devices

Fig 16. Diode Reverse Recovery Test Circuit for P-Channel HEXFET® Power MOSFETs

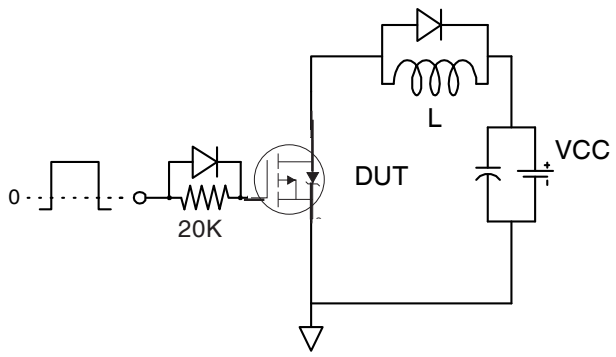


Fig 17a. Gate Charge Test Circuit

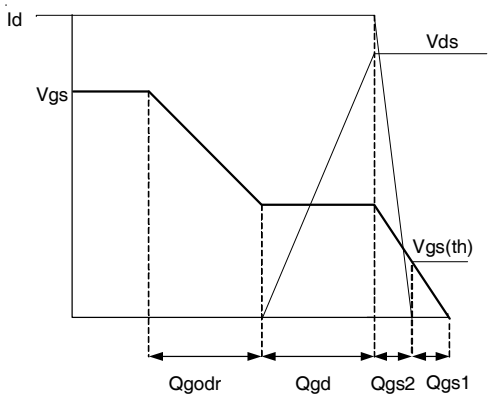


Fig 17b. Gate Charge Waveform

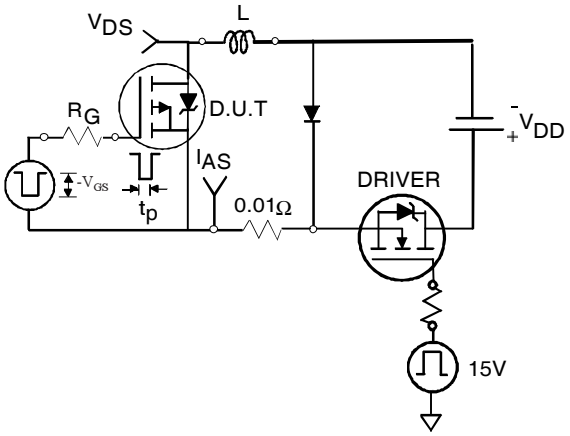


Fig 18a. Unclamped Inductive Test Circuit

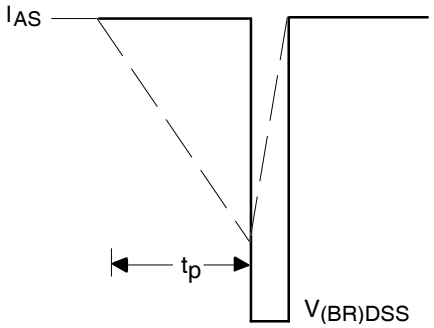


Fig 18b. Unclamped Inductive Waveforms

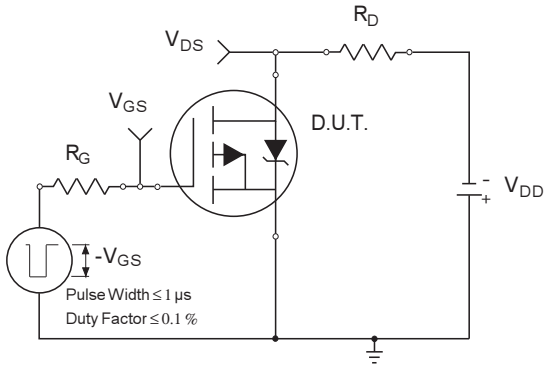


Fig 19a. Switching Time Test Circuit

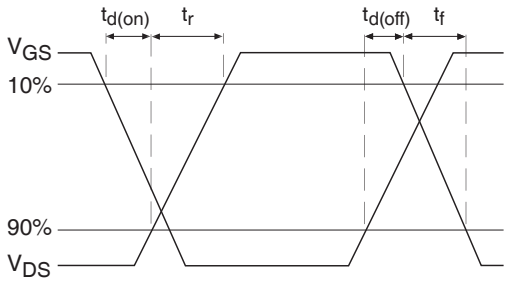
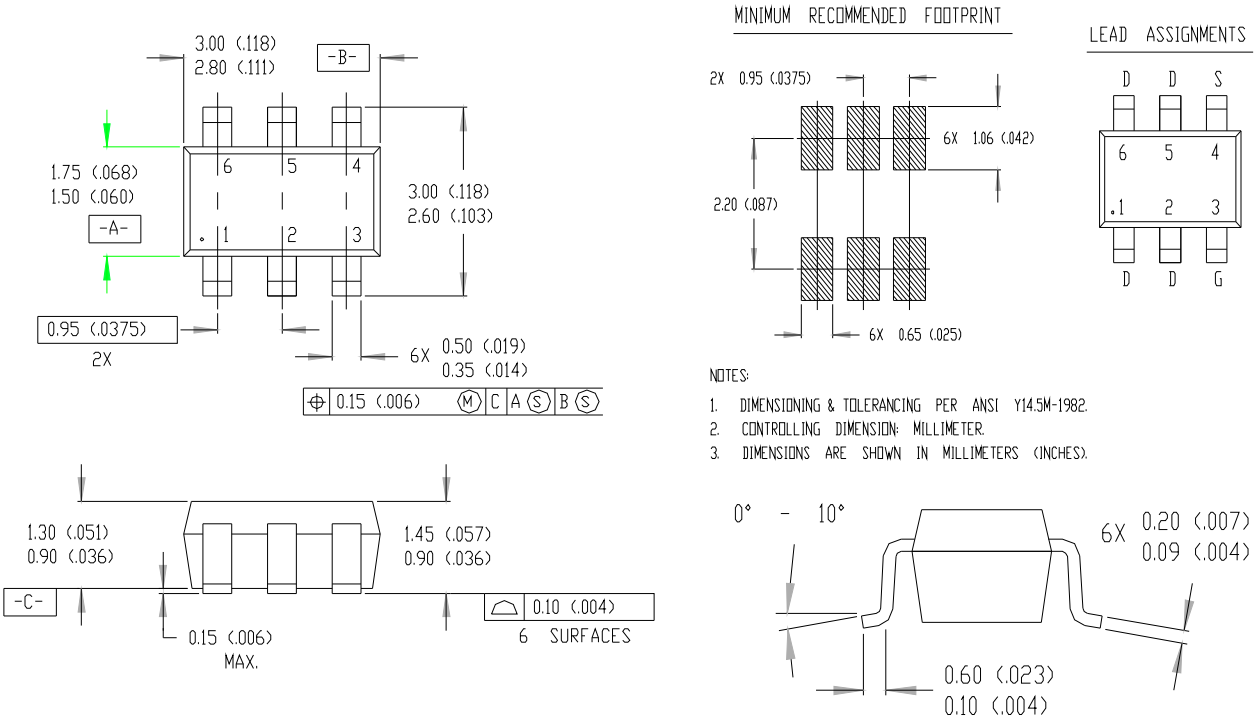
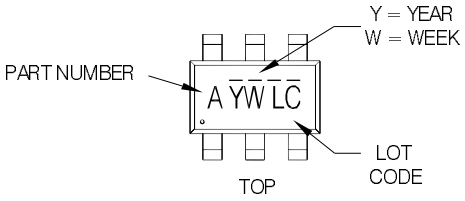


Fig 19b. Switching Time Waveforms

TSOP-6 Package Outline



TSOP-6 Part Marking Information



PART NUMBER CODE REFERENCE:

A = SI3443DV	O = IRLTS6342TRPBF
B = IRF5800	P = IRFTS8342TRPBF
C = IRF5850	R = IRFTS9342TRPBF
D = IRF5851	S = IRLTS2242TRPBF
E = IRF5852	
F = IRF5801	
G = IRF5803	
H = IRF5804	
I = IRF5805	
J = IRF5806	
K = IRF5810	
N = IRF5802	

Note: A line above the work week
(as shown here) indicates Lead-Free.

W = (1-26) IF PRECEDED BY LAST DIGIT OF CALENDAR YEAR

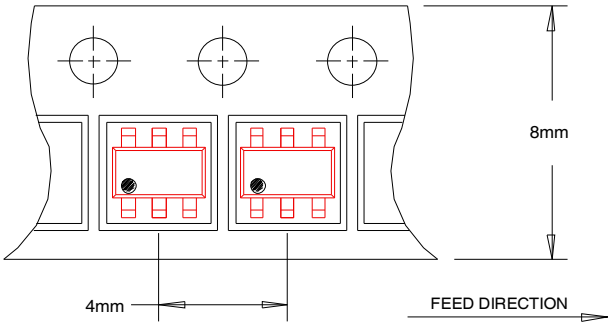
YEAR	Y	WORK WEEK	W
2001	1	01	A
2002	2	02	B
2003	3	03	C
2004	4	04	D
2005	5		
2006	6		
2007	7		
2008	8		
2009	9		
2010	0	24	X
		25	Y
		26	Z

W = (27-52) IF PRECEDED BY A LETTER

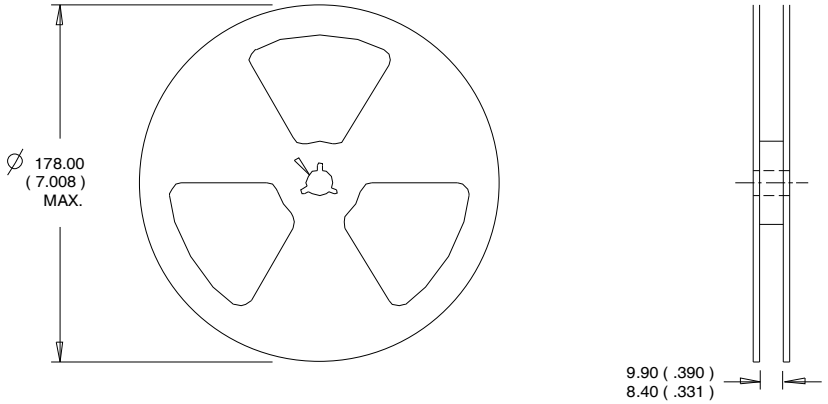
YEAR	Y	WORK WEEK	W
2001	A	27	A
2002	B	28	B
2003	C	29	C
2004	D	30	D
2005	E		
2006	F		
2007	G		
2008	H		
2009	J		
2010	K	50	X
		51	Y
		52	Z

Note: For the most current drawing please refer to IR website at: http://www.irf.com/package/

TSOP-6 Tape and Reel Information



NOTES :
1. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES:
1. CONTROLLING DIMENSION : MILLIMETER.
2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Qualification information†

Qualification level	Consumer†† (per JEDEC JESD47F ††† guidelines)	
Moisture Sensitivity Level	TSOP-6	MSL1 (per IPC/JEDEC J-STD-020D†††)
RoHS compliant	Yes	

† Qualification standards can be found at International Rectifier's web site http://www.irf.com/product-info/reliability

†† Higher qualification ratings may be available should the user have such requirements. Please contact your International Rectifier sales representative for further information: http://www.irf.com/whoto-call/salesrep/

††† Applicable version of JEDEC standard at the time of product release.

Data and specifications subject to change without notice.

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